

## The Embedded I/O Company

# TAMC200 AMC Carrier for 3 IndustryPacks®



### **Application Information**

The TAMC200 is a standard double Mid-Size/Full-Size AMC.1 (PCI-Express) compliant carrier for up to three single-size or one double-size and one single-size IndustryPack (IP) modules used to build modular, flexible and cost effective I/O solutions for all kinds of applications like process control, medical systems, telecommunication and traffic control. Three VHD68 SCSI-V (VHDCI/Champ) type connectors provide access to all IP I/O lines.

The TAMC200 is a versatile solution to upgrade well known legacy I/O solutions to a high performance form factor.

All IP interrupt request lines are mapped to PCIe INTA, alternatively Message Signaled Interrupts (MSI) can be used. For fast interrupt source detection the TAMC200 provides a special IP interrupt status register.

The IP power lines are fuse protected by self-healing fuses and RF filtered. The operating temperature range is  $-40^{\circ}$ C to  $+85^{\circ}$ C.

According to AMC.0, the TAMC200 provides an IPMI compliant Module Management Controller (MMC) with temperature monitoring and hot-swap support.

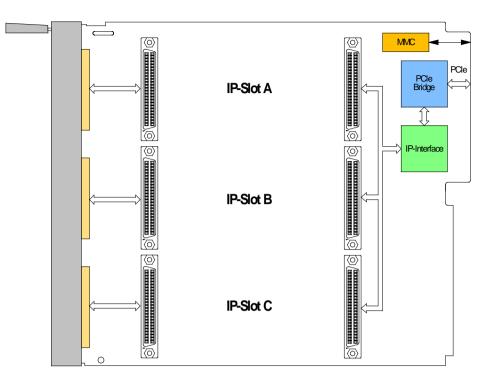
### **Technical Information**

- Form Factor: PCIMG AMC.1 Module
  - O Board size: 180.6mm x 146.5mm
  - O Double Mid-Size or Full-Size front panel
- Fabric Interface:
  - PCIe single lane (x1) on AMC Port 4 (AMC.1 Type 1 compliant)
- O IPMI V1.5 Support
- Front Panel LEDs:
  - O Blue Hot-Swap LED
  - O Red Fail LED (LED1)
  - O Green Power Good / Activity LED (LED 2)
- ANSI/VITA 4-1995 compliant interface to three IndustryPack modules
  - 3 IndustryPack slots: three single-size IPs or one single-size and one double-size IP
  - O 8/32 MHz interface, no DMA
  - O 8 Mbytes memory space per IP Slot
  - Routing of all IP interrupts to PCIe INTA/MSI, local interrupt status register
  - O I/O access: VHD68 SCSI-V (VHDCI/Champ) type connector per IP
- O Self-Healing fuses and RF-filtering on all IP power lines
- O Operating temperature: -40°C to +85°C
- O MTBF (MIL-HDBK217F/FN2 G<sub>B</sub> 20°C): 250.000 h

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#### **Order Information**

### **RoHS Compliant**

TAMC200-10R	3 Slot IndustryPack Carrier, Double Mid-Size*)
TAMC200-11R	3 Slot IndustryPack Carrier, Double Full-Size

\*) Please note that the mid-size module has restrictions to its usage because of a component height violation. It is within the responsibility of the user to carefully check if the mid-size module with its component height violation can be used in his system. Otherwise damage of the TAMC200 or its slot to be used in may occur! For more information see the user manual TAMC200-DOC

For the availability of non-RoHS compliant (leaded solder) products please contact TEWS.

### Documentation TAMC200-DOC

For other operating systems please contact TEWS.

User Manual

#### **Related Products**

TA307 Cable Kit for Modules with VHD68 Connector

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